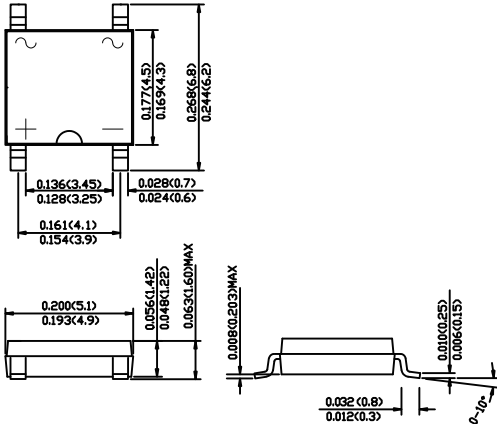


ABS2 THRU ABS10

SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIERS

Voltage Range - 200 to 1000 Volts Current - 0.8/1.0 Ampere

ABS



Dimensions in inches and (millimeters)

FEATURES

- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction utilizing molded plastic technique
- ◆ High temperature soldering guaranteed: 260°C/10 seconds at 5 lbs., (2.3kg) tension
- ◆ Small size, simple installation
- ◆ High surge current capability
- ◆ Glass passivated chip junction
- ◆ Green compound(halogen&Sb₂O₃ free)

MECHANICAL DATA

Case: Molded plastic body

Terminals: Plated leads solderable per MIL-STD-750, Method 2026

Polarity: Polarity symbols marked on case

Mounting Position: Any

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load derate current by 20%.

| | SYMBOLS | ABS2 | ABS4 | ABS6 | ABS8 | ABS10 | UNITS |
|--|--------------------------------------|------|------|------|-------------|-------|-------|
| Maximum repetitive peak reverse voltage | V _{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V _{RMS} | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V _{DC} | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum average forward rectified current | | | | | | | |
| On glass-epoxy P.C.B.(Note1) | I _{F(AV)} | | | 0.8 | | | A |
| On aluminum substrate(Note2) | | | | 1.0 | | | |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | | | 30 | | | A |
| Maximum instantaneous forward voltage drop per leg at 0.4A | V _F | | | 0.95 | | | V |
| Maximum DC reverse current | | | | | 5 | | uA |
| at rated DC blocking voltage | I _R | | | | 100 | | uA |
| Typical thermal resistance(NOTE 3) | R _{θJL} R _{θJA} | | | | 25 75 | | °C/W |
| Operating temperature range | T _J | | | | -55 to +150 | | °C |
| storage temperature range | T _{STG} | | | | -55 to +150 | | °C |

NOTES:1. On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads

2. On aluminum substrate P.C.B. with an area of 0.8"x0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad

3. Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.

RATINGS AND CHARACTERISTIC CURVES ABS2 THRU ABS10

FIG.1 FORWARD DERATING CURVE

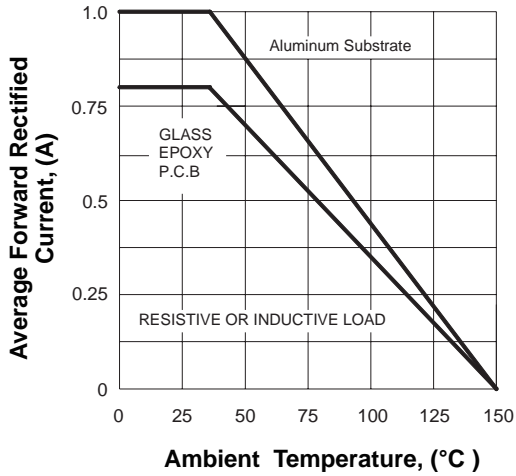


FIG.2 PEAK FORWARD SURGE CURRENT

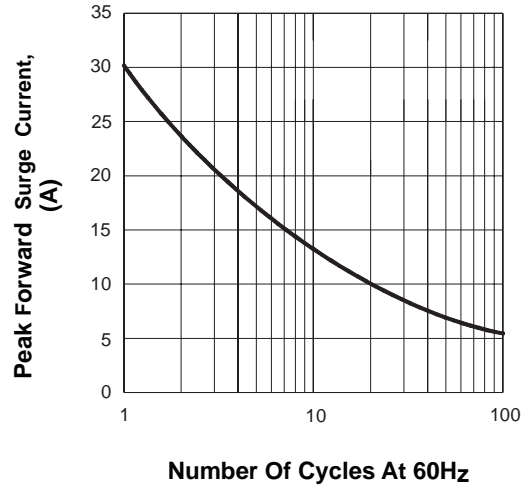


FIG.3 TYPICAL FORWARD CHARACTERISTICS

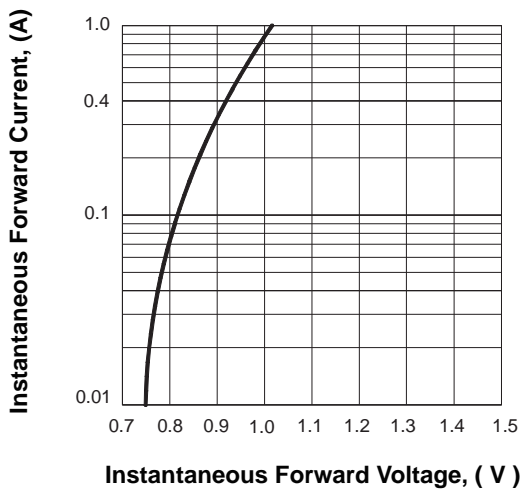
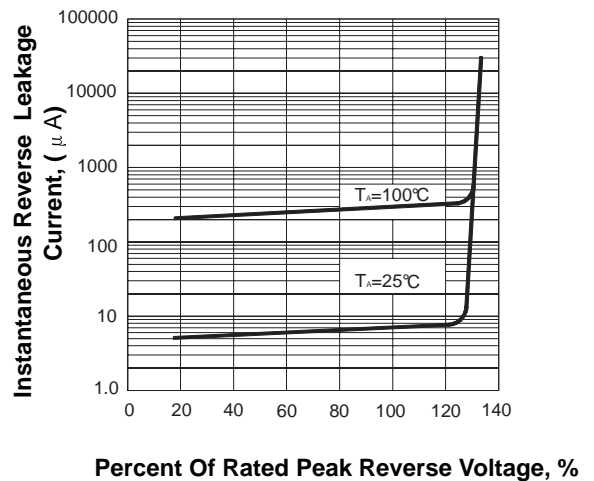


FIG.4 TYPICAL REVERSE CHARACTERISTICS



单击下面可查看定价，库存，交付和生命周期等信息

[>>STAR_SEA\(星海\)](#)